Power MOSFET 30 V, 57 A, Single N–Channel, μ8FL

Features

- Small Footprint (3.3 x 3.3 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- DC–DC Converters
- High Side Switching

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Param	Symbol	Value	Unit		
Drain-to-Source Voltage	Drain-to-Source Voltage				
Gate-to-Source Voltage	V _{GS}	±20	V		
Continuous Drain		$T_A = 25^{\circ}C$	I _D	13.5	А
Current R _{θJA} (Note 1)		$T_A = 85^{\circ}C$		9.7	
Power Dissipation $R_{\theta JA}$ (Note 1)		$T_A = 25^{\circ}C$	P _D	2.1	W
Continuous Drain		T _A = 25°C	Ι _D	18.6	А
Current R _{θJA} ≤ 10 s (Note 1)		T _A = 85°C		13.4	
Power Dissipation $R_{\theta JA} \leq 10 \text{ s} \text{ (Note 1)}$	Steady	T _A = 25°C	P _D	4.1	W
Continuous Drain	State	$T_C = 25^{\circ}C$	۱ _D	7.5	А
Current R _{0JA} (Note 2)		T _C = 85°C		5.4	
Power Dissipation $R_{\theta JA}$ (Note 2)		T _C = 25°C	P _D	0.66	W
Continuous Drain		$T_{C} = 25^{\circ}C$	I _D	57	А
Current $R_{\theta JC}$ (Note 1)		$T_{\rm C} = 85^{\circ}{\rm C}$		41	
Power Dissipation $R_{\theta JC}$ (Note 1)		$T_C = 25^{\circ}C$	PD	38.5	W
Pulsed Drain Current	T _A = 25°0	C, t _p = 10 μs	I _{DM}	171	А
Operating Junction and S	itorage Ten	nperature	T _J , T _{stg}	–55 to +150	°C
Source Current (Body Die		۱ _S	38.5	А	
Drain to Source dV/dt	dV/dt	6.0	V/ns		
$ Single Pulse Drain-to-So \\ (T_J = 25^\circ C, V_{DD} = 50 \text{ V}, \text{ V} \\ I_L = 33 \text{ A}_{pk}, \text{ L} = 0.1 \text{ mH}, \text{ F} $	E _{AS}	55	mJ		
Lead Temperature for So (1/8" from case for 10 s)	dering Pur	poses	ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.

2. Surface-mounted on FR4 board using the minimum recommended pad size.

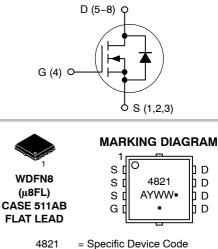


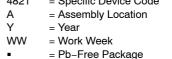
ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
30 V	7.0 mΩ @ 10 V	57 A
30 V	10.8 mΩ @ 4.5 V	37 K

N-Channel MOSFET





(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NTTFS4821NTAG	WDFN8 (Pb-Free)	1500/Tape & Reel
NTTFS4821NTWG	WDFN8 (Pb-Free)	5000/Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	3.25	°C/W
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	58.3	
Junction-to-Ambient - Steady State (Note 4)	$R_{\theta JA}$	188.4	
Junction-to-Ambient – (t \leq 10 s) (Note 3)	R _{θJA}	30.6	

Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
Surface-mounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Conditi	on	Min	Тур	Max	Unit
OFF CHARACTERISTICS			Į			Į	1
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 2$	50 μΑ	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				25		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			1.0	μΑ
			$T_J = 125^{\circ}C$			10	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} =	±20 V			±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μΑ	1.5	1.9	2.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				6		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$I_{\rm D} = 20$			5.8	7.0	mΩ
		V _{GS} = 10 V to 11.5 V	I _D = 10 A		5.7		
			I _D = 20 A		8.8	10.8	1

CHARGES AND CAPACITANCES

Forward Transconductance

Input Capacitance	C _{iss}		1300	1755	pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 12 V	300	405	
Reverse Transfer Capacitance	C _{rss}		150	233	
Total Gate Charge	Q _{G(TOT)}		10.5	15	nC
Threshold Gate Charge	Q _{G(TH)}		1.3		
Gate-to-Source Charge	Q _{GS}	V_{GS} = 4.5 V, V_{DS} = 15 V, I_{D} = 30 A	3.9		
Gate-to-Drain Charge	Q _{GD}		4.5		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 11.5 V, V_{DS} = 15 V, I_{D} = 20 A	24		nC

V_{GS} = 4.5 V

 $V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$

 $I_{\rm D} = 10 \, {\rm A}$

8.6

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SWITCHING CHARACTERISTICS (Note 6)

Turn-On Delay Time	t _{d(on)}		12	ns
Rise Time	t _r	V _{GS} = 4.5 V, V _{DS} = 15 V,	22	
Turn-Off Delay Time	t _{d(off)}	$I_{\rm D}$ = 15 A, R _G = 3.0 Ω	16	
Fall Time	t _f		4.5	

5. Pulse Test: pulse width = 300 $\mu s,$ duty cycle \leq 2%.

6. Switching characteristics are independent of operating junction temperatures.

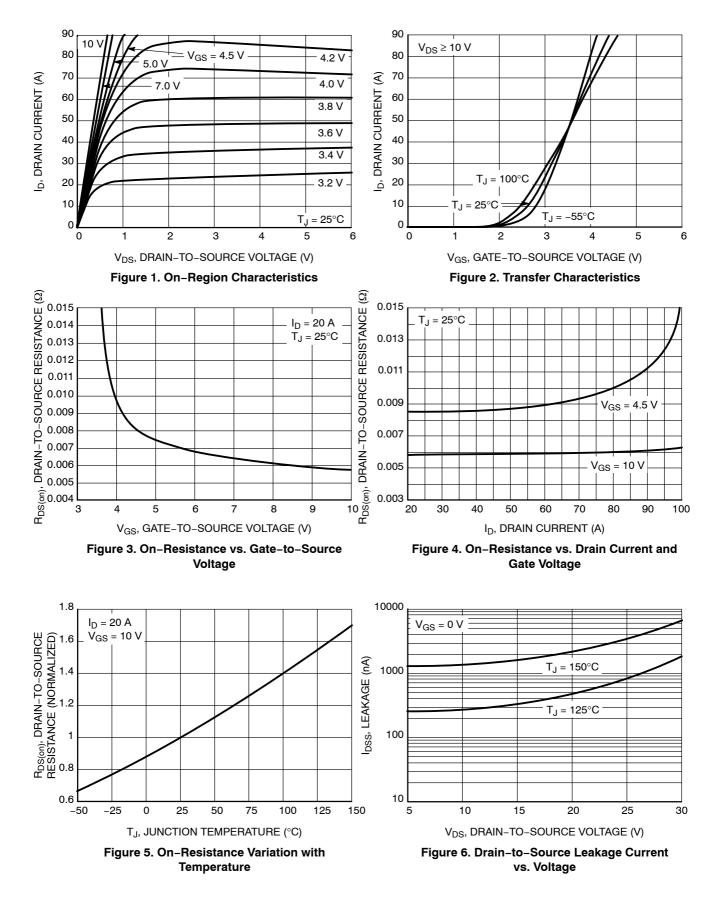
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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

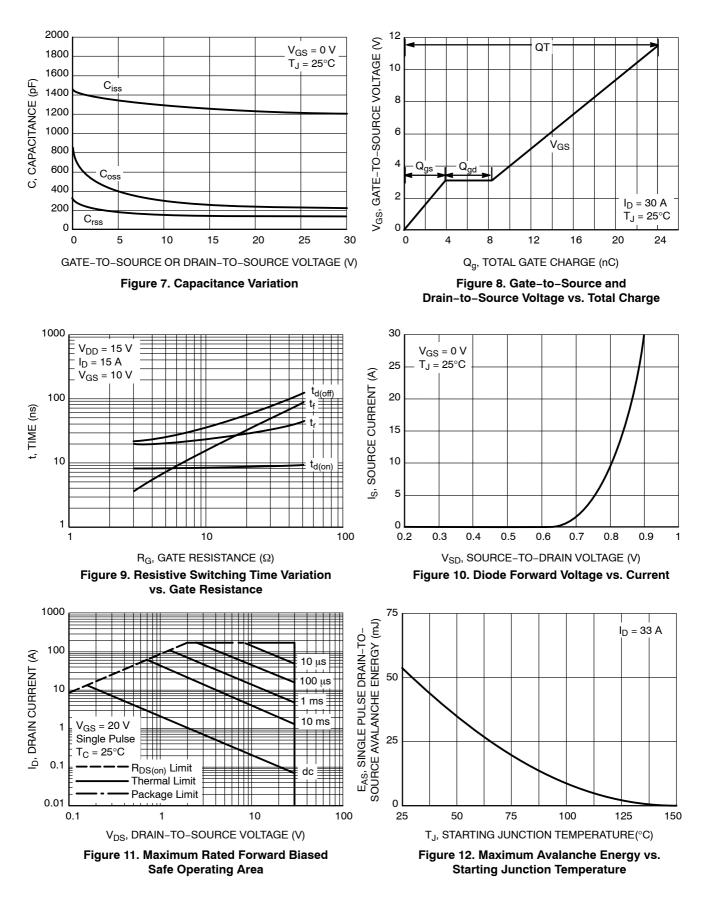
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS	S (Note 6)				•	•	
Turn-On Delay Time	t _{d(on)}	V _{GS} = 11.5 V, V _{DS} = 15 V,			8.5		ns
Rise Time	t _r				20		1
Turn-Off Delay Time	t _{d(off)}	I _D = 15 A, R _G =	3.0 Ω		23		1
Fall Time	t _f				2.8		1
DRAIN-SOURCE DIODE CHARA	CTERISTICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V$, $T_J = 25^{\circ}C$			0.9	1.0	V
		$I_{\rm S} = 20 \rm A$	T _J = 125°C		0.78		1
Reverse Recovery Time	t _{RR}				9.0		ns
Charge Time	ta	$V_{GS} = 0 V,$	/		6.5		1
Discharge Time	t _b	d _{IS} /d _t = 100 A/μs, I _S = 20 A			2.5		1
Reverse Recovery Charge	Q _{RR}				1.7		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L _S	T _A = 25°C			0.38		nH
Drain Inductance	L _D				0.054		1
Gate Inductance	L _G				1.3		1
Gate Resistance	R _G				0.6	2.0	Ω

 $\begin{array}{ll} \text{5. Pulse Test: pulse width = 300 } \mu\text{s, duty cycle } \leq 2\%. \\ \text{6. Switching characteristics are independent of operating junction temperatures.} \end{array}$

TYPICAL CHARACTERISTICS

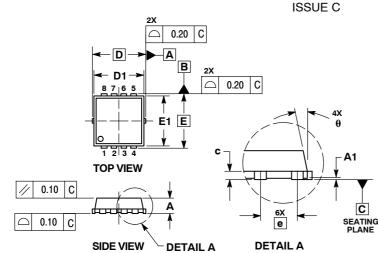


TYPICAL CHARACTERISTICS



PACKAGE DIMENSIONS

WDFN8 3.3x3.3, 0.65P CASE 511AB



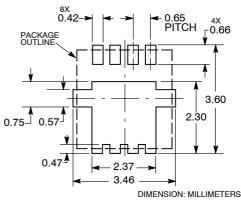
8) 0.10 С A В ŧ 0.05 С e/2 4X - - - Hithe A E2 Ез₫ М V D2 G-**BOTTOM VIEW**

NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 1. 2. CONTROLLING DIMENSION: MILLIMETERS
- DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS. з

	MI	LLIMETE	RS	INCHES				
DIM	MIN	NOM	MAX	MIN	NOM	MAX		
Α	0.70	0.75	0.80	0.028	0.030	0.031		
A1	0.00		0.05	0.000		0.002		
b	0.23	0.30	0.40	0.009	0.012	0.016		
с	0.15	0.20	0.25	0.006	0.008	0.010		
D		3.30 BSC		C	.130 BSC	;		
D1	2.95	3.05	3.15	0.116	0.120	0.124		
D2	1.98	2.11	2.24	0.078	0.083	0.088		
Е		3.30 BSC			.130 BSC)		
E1	2.95	3.05	3.15	0.116	0.120	0.124		
E2	1.47	1.60	1.73	0.058	0.063	0.068		
E3	0.23	0.30	0.40	0.009	0.012	0.016		
е	0.65 BSC			C	.026 BSC	;		
G	0.30	0.41	0.51	0.012	0.016	0.020		
к	0.64			0.025				
L	0.30	0.43	0.56	0.012	0.017	0.022		
L1	0.06	0.13	0.20	0.002	0.005	0.008		
м	1.40	1.50	1.60	0.055	0.059	0.063		
θ	0°		12°	0°		12°		

SOLDERING FOOTPRINT*



*For additional information on our Pb -Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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